

Surface Mount Fast Recovery Rectifiers

Reverse Voltage - 50 to 1000 V

Forward Current - 3 A

FEATURES

- ◆ For surface mounted applications
- ◆ Low profile package
- ◆ Glass Passivated Chip Junction
- ◆ Easy to pick and place
- ◆ Fast reverse recovery time
- ◆ Lead free in comply with EU RoHS 2011/65/EU directives

MECHANICAL DATA

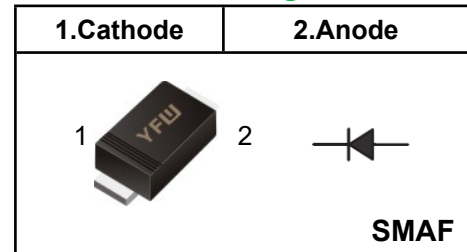
- ◆ Case: SMAF
- ◆ Terminals: Solderable per MIL-STD-750, Method 2026
- ◆ Approx. Weight: 27mg / 0.00095oz

Absolute Maximum Ratings and characteristics

Ratings at 25 °C ambient temperature unless otherwise specified.

Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Pinning



Marking Code

RS3AF	RS3A
RS3BF	RS3B
RS3DF	RS3D
RS3GF	RS3G
RS3JF	RS3J
RS3KF	RS3K
RS3MF	RS3M

Parameter	Symbols	RS3AF	RS3BF	RS3DF	RS3GF	RS3JF	RS3KF	RS3MF	Units	
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V	
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V	
Maximum DC Blocking Voltage	V_{DC}	50	100	200	400	600	800	1000	V	
Maximum Average Forward Rectified Current at $T_c = 125\text{ }^\circ\text{C}$	$I_{F(AV)}$	3							A	
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load	I_{FSM}	100							A	
Maximum Instantaneous Forward Voltage at 3 A	V_F	1.3							V	
Maximum DC Reverse Current $T_a = 25\text{ }^\circ\text{C}$ at Rated DC Blocking Voltage $T_a = 125\text{ }^\circ\text{C}$	I_R	5 100							μA	
Typical Junction Capacitance at $V_R=4\text{V}, f=1\text{MHz}$	C_j	32							pF	
Maximum Reverse Recovery Time ⁽¹⁾	T_{rr}	150				250		500		nS
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}/ R_{\theta JC}$	50/16							$^\circ\text{C/W}$	
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150							$^\circ\text{C}$	

(1) Measured with $I_F=0.5\text{A}, I_R=1\text{A}, I_n=0.25\text{A}$

(2) P.C.B. mounted with 2.0" X 2.0" (5 X 5 cm) copper pad areas.

Fig.1 Maximum Average Forward Current Rating

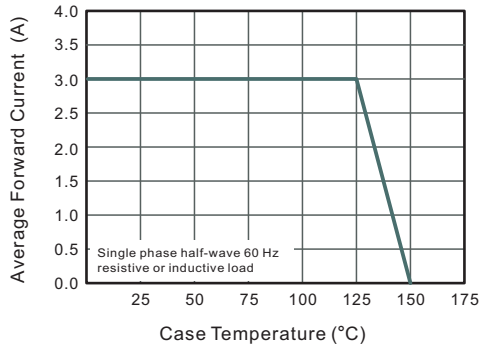


Fig.2 Typical Reverse Characteristics

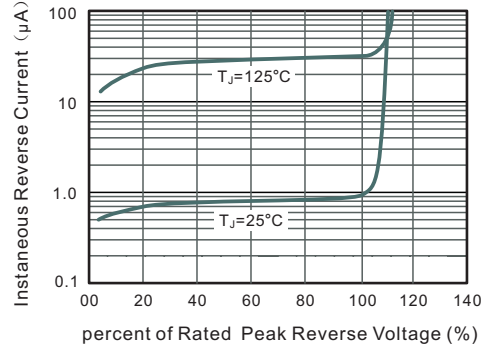


Fig.3 Typical Instantaneous Forward Characteristics

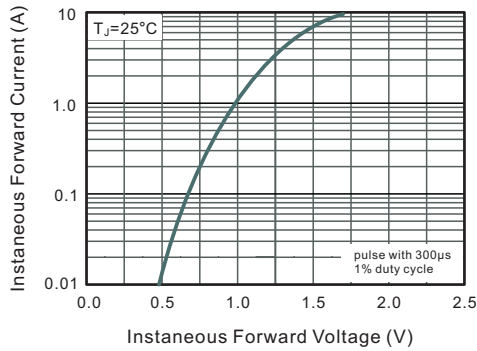


Fig.4 Typical Junction Capacitance

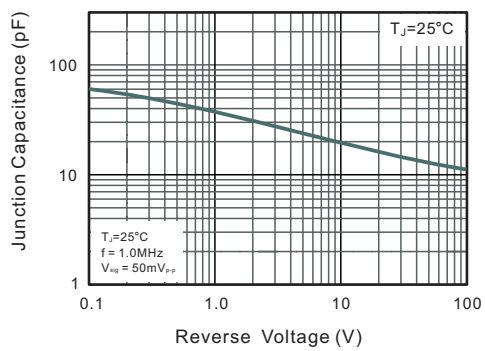
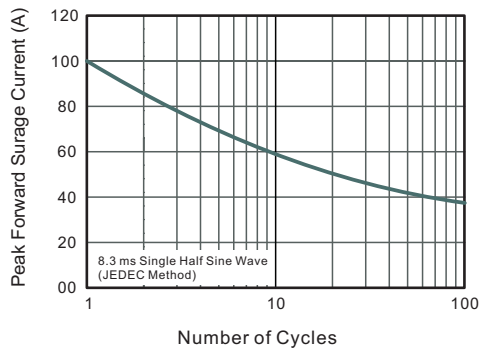


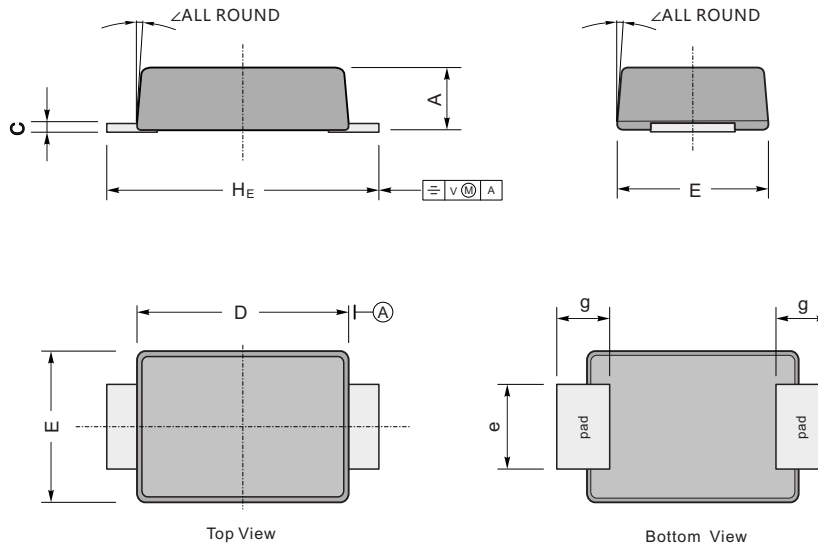
Fig.5 Maximum Non-Repetitive Peak Forward Surge Current



Package Outline

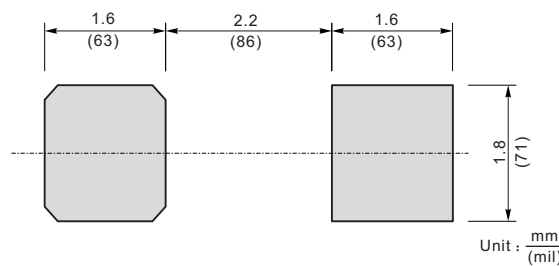
SMAF

Plastic surface mounted package; 2 leads



UNIT		A	C	D	E	e	g	H _E	\angle
mm	max	1.1	0.20	3.7	2.7	1.6	1.2	4.9	7°
	min	0.9	0.12	3.3	2.4	1.3	0.8	4.4	
mil	max	43	7.9	146	106	63	47	193	
	min	35	4.7	130	94	51	31	173	

The recommended mounting pad size



Summary of Packing Options

Package	Packing Description	Packing Quantity	Industry Standard
SMAF	Tape/Reel, 13" reel	10000	EIA-481-1
	Tape/Reel, 7" reel	3000	EIA-481-1